

SURFACE MOUNT ULTRA HIGH SPEED SILICON SWITCHING DIODE



APPLICATIONS:

- DC / DC Converters
- Voltage Clamping
- Protection Circuits
- Battery powered applications including Cell Phones, Digital Cameras, Pagers, PDAs, Laptop Computers, etc.



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMAD4448 is an ultra high speed switching diode ideal for applications where very small size and operational efficiency are prime requirements.

MARKING CODE: M

FEATURES:

- Current (I_O=250mA)
- Forward Voltage Drop (V_F=0.91V TYP @ 100mA)
- Extremely Fast Switching Speed (4ns Max)
- Miniture, 0.8 x 0.6 x 0.4mm, ultra low height profile **FEMTO**mini[™] Surface Mount Package.

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V _{RRM}	120	V
Continuous Forward Current	۱ _F	250	mA
Peak Repetitive Forward Current	IFRM	500	mA
Peak Forward Surge Current, tp=1.0µs	IFSM	4.0	А
Peak Forward Surge Current, tp=1.0s	IFSM	1.0	А
Power Dissipation	PD	100	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	Θ_{JA}	1250	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _R	V _R =50V			300	nA
I _R	V _R =50V, T _A =125°C			100	μA
I _R	V _R =100V			500	nA
вv _R	I _R =100μΑ	120	150		V
V _F	I _F =1.0mA	0.55	0.59	0.65	V
V _F	I _F =10mA	0.67	0.72	0.77	V
V _F	I _F =100mA	0.85	0.91	1.0	V
с _Т	V _R =0, f=1.0MHz			2.0	pF
t _{rr}	I _R =I _F =10mA, R _L =100Ω, Rec. to 1.0mA		2.0	4.0	ns

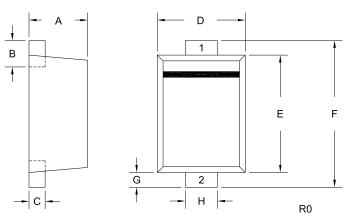
R1 (8-January 2010)



CMAD4448

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SOD-923 CASE - MECHANICAL OUTLINE



LEAD CODE: 1) CATHODE 2) ANODE

DIMENSIONS INCHES MILLIMETERS SYMBOL MIN MAX MIN MAX А 0.015 0.016 0.39 0.41 В 0.004 0.010 0.10 0.26 С 0.003 0.006 0.08 0.14 D 0.022 0.026 0.55 0.65 Е 0.030 0.033 0.75 0.85 F 0.035 0.043 0.90 1.10 G 0.002 0.006 0.05 0.15 Н 0.007 0.011 0.17 0.27

SOD-923 (REV: R0)

2) ANODE MARKING CODE: M

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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